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APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO. CONFIRMATION NO. 09/912,739 07/26/2001 Pei-Haw Tsao TS00-823 5609

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06'04/2003

GEORGE O. SAILE & ASSOCIATES 28 DAVIS AVENUE POUGHKEEPSIE, NY 12603

EXAMINER

CHAMBLISS, ALONZO

ART UNIT PAPER NUMBER

2827

DATE MAILED: 06/04/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

· Supple merital	Application No.	Applicant(s)	Applicant(s)	
Notice of Allowability	09/912,739	TSAO ET AL.		
Notice of Allowability	Examiner	Art Unit		
	Alonzo Chambliss	2827		
The MAILING DATE of this communication apperation apperation apperation and all claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIGHT of the Office or upon petition by the applicant. See 37 CFR 1.313 of the Office or upon petition by the applicant. See 37 CFR 1.313 of the Office or upon petition by the applicant. See 37 CFR 1.313 of the Office or upon petition by the applicant. See 37 CFR 1.313 of the Office or upon petition by the applicant is responsive to notice of allowance find the Office of the Allowance find the Office of the Office of allowance find the Office of the Office of allowance find the Office of allowance find the Office of allowance find the Office of the Office of allowance find	cars on the cover sheet with (OR REMAINS) CLOSED in or other appropriate communication is so and MPEP 1308. Seed on 3/12/03. Seed on 3/12/03. Seed on 12/03. Seed on 12/03	th the correspondence additions application. If not include in distribution will be mailed in distribution with the correspondence addition will be mailed in distribution with the correspondence addition. (f). (f). In No In this national stage application). In provisional application).	uded ue course. THIS sue at the initiativ	
7. A SUBSTITUTE OATH OR DECLARATION must be subm INFORMAL PATENT APPLICATION (PTO-152) which gives reason	itted. Note the attached EXA	MINIED'S AMENIDMENT		
 8. CORRECTED DRAWINGS must be submitted. (a) including changes required by the Notice of Draftspers 1) hereto or 2) to Paper No. (b) including changes required by the proposed drawing or (c) including changes required by the attached Examiner's Identifying indicia such as the application number (see 37 CFR 1.8 each sheet. 	orrection filed, which s Amendment / Comment or	n has been approved by the in the Office action of Pape	r No	
9. DEPOSIT OF and/or INFORMATION about the depos attached Examiner's comment regarding REQUIREMENT FOR THE	it of BIOLOGICAL MATE	RIAL must be submitted. AL MATERIAL.	Note the	
Attachment(s)				
 1 Notice of References Cited (PTO-892) 3 Notice of Draftperson's Patent Drawing Review (PTO-948) 5 Information Disclosure Statements (PTO-1449), Paper No	4☐ Interview : 6⊠ Examiner'	Informal Patent Application Summary (PTO-413), Pape s Amendment/Comment s Statement of Reasons for	r No	

Application/Control Number: 09/912,739

Art Unit: 2827

DETAILED ACTION

EXAMINER'S AMENDMENT

1. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Stephen B. Ackerman on March 10, 2003 2.

2. The application has been amended as follow:

IN CLAIMS:

In claim 1, line 16, delete "there-of" and insert instead -- to allow direct physical contact with die thereby reducing the stress on solder ball connections between the semiconductor die and the substrate --;

In claim 11, line 49, after "adhesive layer "insert -- to allow direct physical contact with die thereby reducing the stress on solder ball connections between the semiconductor die and the substrate --.

Allowable Subject Matter

3. The following is a statement of reasons for the indication of allowance subject matter: the prior art of record does not teach or suggest the combination of a die mounted on a substrate. A stiffener attached to a substrate by an adhesive interface, wherein a heat spreader having at least one grove across is attached to the adhesive

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interface. The heat spreader is in direct physical contact with the semiconductor die thereby reducing the stress on solder ball connections between the semiconductor die and the substrate.

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Any inquiry concerning the communication or earlier communications from the examiner should be directed to Alonzo Chambliss whose telephone number is (703) 306-9143. The fax phone number for the Group is (703) 308-772 or 7724.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the group receptionist whose telephone number is (703) 308-7956.

DAVID E. GRAYBILL PRIMARY EXAMINER

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AC/May 27, 2003